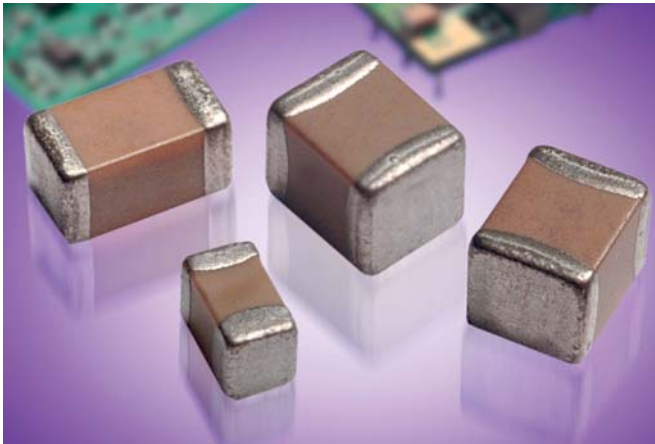


# COG (NP0) Dielectric

## General Specifications



COG (NP0) is the most popular formulation of the "temperature-compensating," EIA Class I ceramic materials. Modern COG (NP0) formulations contain neodymium, samarium and other rare earth oxides.

COG (NP0) ceramics offer one of the most stable capacitor dielectrics available. Capacitance change with temperature is  $0 \pm 30 \text{ ppm}/^\circ\text{C}$  which is less than  $\pm 0.3\% \Delta C$  from  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$ . Capacitance drift or hysteresis for COG (NP0) ceramics is negligible at less than  $\pm 0.05\%$  versus up to  $\pm 2\%$  for films. Typical capacitance change with life is less than  $\pm 0.1\%$  for COG (NP0), one-fifth that shown by most other dielectrics. COG (NP0) formulations show no aging characteristics.



### PART NUMBER (see page 2 for complete part number explanation)

**0805**

**Size**  
(L" x W")

**5**

**Voltage**  
6.3V = 6  
10V = Z  
16V = Y  
25V = 3  
50V = 5  
100V = 1  
200V = 2  
500V = 7

**A**

**Dielectric**  
COG (NP0) = A

**101**

**Capacitance Code (In pF)**  
2 Sig. Digits + Number of Zeros

**J**

**Capacitance Tolerance**  
B =  $\pm 10 \text{ pF}$  ( $< 10 \text{ pF}$ )  
C =  $\pm 25 \text{ pF}$  ( $< 10 \text{ pF}$ )  
D =  $\pm 50 \text{ pF}$  ( $< 10 \text{ pF}$ )  
F =  $\pm 1\%$  ( $\geq 10 \text{ pF}$ )  
G =  $\pm 2\%$  ( $\geq 10 \text{ pF}$ )  
J =  $\pm 5\%$   
K =  $\pm 10\%$

**A**

**Failure Rate**  
A = Not Applicable

**T**

**Terminations**  
T = Plated Ni and Sn

**2**

**Packaging**  
2 = 7" Reel  
4 = 13" Reel  
U = 4mm TR (01005)

**A**

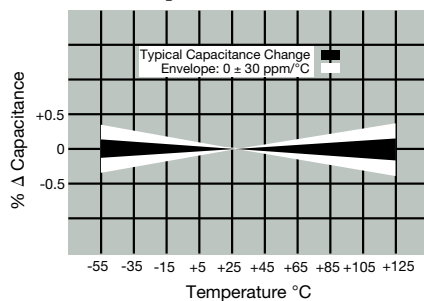
**Special Code**  
A = Std. Product

**Contact Factory For**  
1 = Pd/Ag Term  
7 = Gold Plated  
**NOT RoHS COMPLIANT**

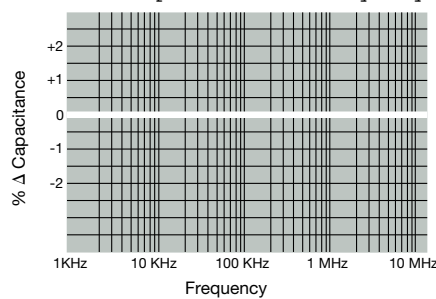
**Contact Factory For Multiples**

NOTE: Contact factory for availability of Termination and Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.

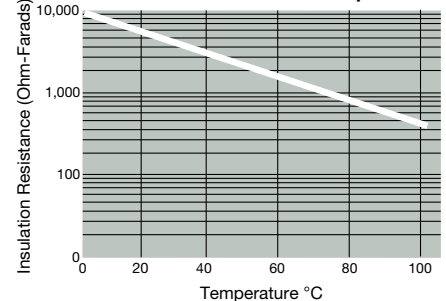
Temperature Coefficient



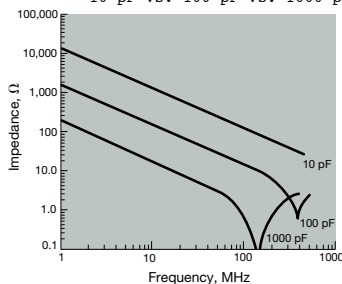
Δ Capacitance vs. Frequency



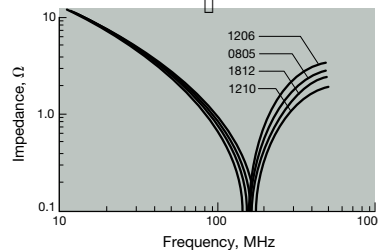
Insulation Resistance vs Temperature



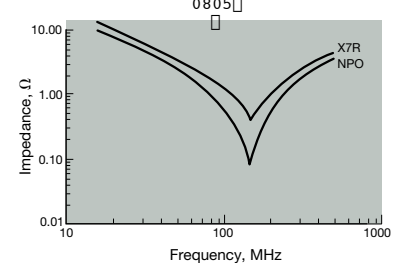
Variation of Impedance with Cap Value  
Impedance vs. Frequency  
0805 - COG (NP0)  
10 pF vs. 100 pF vs. 1000 pF



Variation of Impedance with Chip Size  
Impedance vs. Frequency  
1000 pF - COG (NP0)



Variation of Impedance with Ceramic Formu  
Impedance vs. Frequency  
1000 pF - COG (NP0) vs X7R  
0805



# COG (NP0) Dielectric



## Specifications and Test Methods

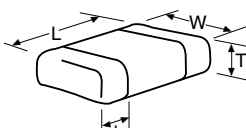
Parameter/Test		NP0 Specification Limits	Measuring Conditions	
<b>Operating Temperature Range</b>		-55°C to +125°C	Temperature Cycle Chamber	
<b>Capacitance</b>		Within specified tolerance	Freq.: 1.0 MHz ± 10% for cap ≤ 1000 pF 1.0 kHz ± 10% for cap > 1000 pF Voltage: 1.0Vrms ± .2V	
<b>Q</b>		<30 pF: Q ≥ 400+20 x Cap Value ≥30 pF: Q ≥ 1000	Charge device with rated voltage for 60 ± 5 secs @ room temp/humidity	
<b>Insulation Resistance</b>		100,000MΩ or 1000MΩ - μF, whichever is less	Charge device with 300% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max) Note: Charge device with 150% of rated voltage for 500V devices.	
<b>Dielectric Strength</b>		No breakdown or visual defects	Deflection: 2mm Test Time: 30 seconds 1mm/sec 	
<b>Resistance to Flexure Stresses</b>	Appearance	No defects		
	Capacitance Variation	±5% or ±.5 pF, whichever is greater		
	Q	Meets Initial Values (As Above)		
	Insulation Resistance	≥ Initial Value x 0.3		
<b>Solderability</b>		≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic solder at 230 ± 5°C for 5.0 ± 0.5 seconds	
<b>Resistance to Solder Heat</b>	Appearance	No defects, <25% leaching of either end terminal	Dip device in eutectic solder at 260°C for 60 seconds. Store at room temperature for 24 ± 2 hours before measuring electrical properties.	
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater		
	Q	Meets Initial Values (As Above)		
	Insulation Resistance	Meets Initial Values (As Above)		
<b>Thermal Shock</b>	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 hours at room temperature	
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes
	Capacitance Variation	≤ ±2.5% or ±.25 pF, whichever is greater	Step 2: Room Temp	≤ 3 minutes
	Q	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes
<b>Load Life</b>	Dielectric Strength	Meets Initial Values (As Above)	Charge device with twice rated voltage in test chamber set at 125°C ± 2°C for 1000 hours (+48, -0).	
	Appearance	No visual defects	Remove from test chamber and stabilize at room temperature for 24 hours before measuring.	
	Capacitance Variation	≤ ±3.0% or ± .3 pF, whichever is greater		
	Q (C=Nominal Cap)	≥ 30 pF: Q ≥ 350 ≥10 pF, <30 pF: Q ≥ 275 +5C/2 <10 pF: Q ≥ 200 +10C		
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)		
<b>Load Humidity</b>	Dielectric Strength	Meets Initial Values (As Above)	Store in a test chamber set at 85°C ± 2°C/ 85% ± 5% relative humidity for 1000 hours (+48, -0) with rated voltage applied.	
	Appearance	No visual defects	Remove from chamber and stabilize at room temperature for 24 ± 2 hours before measuring.	
	Capacitance Variation	≤ ±5.0% or ± .5 pF, whichever is greater		
	Q	≥ 30 pF: Q ≥ 350 ≥10 pF, <30 pF: Q ≥ 275 +5C/2 <10 pF: Q ≥ 200 +10C		
<b>Insulation Resistance</b>	Insulation Resistance	≥ Initial Value x 0.3 (See Above)		
	Dielectric Strength	Meets Initial Values (As Above)		

# COG (NP0) Dielectric

## Capacitance Range

PREFERRED SIZES ARE SHADED

SIZE	0101*			0201			0402			0603					0805					1206																																																																																																																																																																																																																																																																																							
Soldering	Reflow Only			Reflow Only			Reflow/Wave			Reflow/Wave					Reflow/Wave					Reflow/Wave																																																																																																																																																																																																																																																																																							
Packaging	All Paper			All Paper			All Paper			All Paper					Paper/Embossed					Paper/Embossed																																																																																																																																																																																																																																																																																							
(L) Length	mm 0.40 ± 0.02 (0.016 ± 0.0008)			mm 0.60 ± 0.09 (0.024 ± 0.004)			mm 1.00 ± 0.10 (0.040 ± 0.004)			mm 1.60 ± 0.15 (0.063 ± 0.006)					mm 2.01 ± 0.20 (0.079 ± 0.008)					mm 3.20 ± 0.20 (0.126 ± 0.008)																																																																																																																																																																																																																																																																																							
(W) Width	mm 0.20 ± 0.02 (0.008 ± 0.0008)			mm 0.30 ± 0.09 (0.011 ± 0.004)			mm 0.50 ± 0.10 (0.020 ± 0.004)			mm 0.81 ± 0.15 (0.032 ± 0.006)					mm 1.25 ± 0.20 (0.049 ± 0.008)					mm 1.60 ± 0.20 (0.063 ± 0.008)																																																																																																																																																																																																																																																																																							
(t) Terminal	mm 0.10 ± 0.04 (0.004 ± 0.0016)			mm 0.15 ± 0.05 (0.006 ± 0.002)			mm 0.25 ± 0.15 (0.010 ± 0.006)			mm 0.35 ± 0.15 (0.014 ± 0.006)					mm 0.50 ± 0.25 (0.020 ± 0.010)					mm 0.50 ± 0.25 (0.020 ± 0.010)																																																																																																																																																																																																																																																																																							
WVDC	16			25 50			16 25 50			16 25 50 100 200					16 25 50 100 200					16 25 50 100 200 500																																																																																																																																																																																																																																																																																							
Cap (pF)	0.5			1.0			1.2			1.5					1.8					2.2					2.7					3.3					3.9					4.7					5.6					6.8					8.2					10					12					15					18					22					27					33					39					47					56					68					82					100					120					150					180					220					270					330					390					470					560					680					820					1000					1200					1500					1800					2200					2700					3300					3900					4700					5600					6800					8200					0.010					0.012					0.015					0.018					0.022					0.027					0.033					0.039					0.047					0.068					0.082					0.1				
Cap (µF)	0.010			0.012			0.015			0.018					0.022					0.027					0.033					0.039					0.047					0.068					0.082					0.1																																																																																																																																																																																																																																																									



Letter	A	B	C	E	G	J	K	M	N	P	Q	X	Y	Z
Max. Thickness	0.33 (0.013)	0.22 (0.009)	0.56 (0.022)	0.71 (0.028)	0.90 (0.035)	0.94 (0.037)	1.02 (0.040)	1.27 (0.050)	1.40 (0.055)	1.52 (0.060)	1.78 (0.070)	2.29 (0.090)	2.54 (0.100)	2.79 (0.110)

PAPER
EMBOSSED

PAPER and EMBOSSED available for 01005

\*EIA 01005

